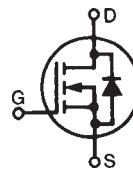


PolarHV™ HiPerFET

IXFN 48N60P Power MOSFET

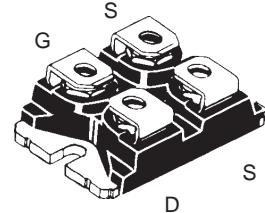
N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Diode



$V_{DSS} = 600$ V
 $I_{D25} = 40$ A
 $R_{DS(on)} \leq 140$ mΩ
 $t_{rr} \leq 200$ ns

Symbol	Test Conditions	Maximum Ratings		
V_{DSS}	$T_J = 25^\circ\text{C}$ to 150°C	600		V
V_{DGR}	$T_J = 25^\circ\text{C}$ to 150°C ; $R_{GS} = 1$ MΩ	600		V
V_{GSS}	Continuous	±30		V
V_{GSM}	Transient	±40		V
I_{D25}	$T_c = 25^\circ\text{C}$	40		A
I_{DM}	$T_c = 25^\circ\text{C}$, pulse width limited by T_{JM}	110		A
I_{AR}	$T_c = 25^\circ\text{C}$	48		A
E_{AR}	$T_c = 25^\circ\text{C}$	70		mJ
E_{AS}	$T_c = 25^\circ\text{C}$	2.0		J
dv/dt	$I_s \leq I_{DM}$, $di/dt \leq 100$ A/μs, $V_{DD} \leq V_{DSS}$, $T_J \leq 150^\circ\text{C}$, $R_G = 2$ Ω	10		V/ns
P_D	$T_c = 25^\circ\text{C}$	625		W
T_J		-55 ... +150		°C
T_{JM}		150		°C
T_{stg}		-55 ... +150		°C
T_L	1.6 mm (0.062 in.) from case for 10 s	300		°C
V_{ISOL}	50/60 Hz, RMS $I_{ISOL} \leq 1$ mA	t = 1 min t = 1 s	2500 3000	V~
M_d	Mounting torque Terminal connection torque	1.5 / 13	Nm/lb.in.	
Weight		30		g

miniBLOC, SOT-227 B (IXFN)
 E153432



G = Gate D = Drain
 S = Source

Either Source terminal S can be used as the Source terminal or the Kelvin Source (gate return) terminal.

Features

- International standard package
- Encapsulating epoxy meets UL 94 V-0, flammability classification
- miniBLOC with Aluminium nitride isolation
- Fast recovery diode
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
 - easy to drive and to protect

Advantages

- Easy to mount
- Space savings
- High power density

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
BV_{DSS}	$V_{GS} = 0$ V, $I_D = 250$ μA	600		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 8$ mA	3.0		V
I_{GSS}	$V_{GS} = \pm 30$ V _{DC} , $V_{DS} = 0$		±200	nA
I_{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0$ V	$T_J = 125^\circ\text{C}$	25	μA
			1000	μA
$R_{DS(on)}$	$V_{GS} = 10$ V, $I_D = 4$ A Pulse test, $t \leq 300$ μs, duty cycle d ≤ 2 %		140	mΩ

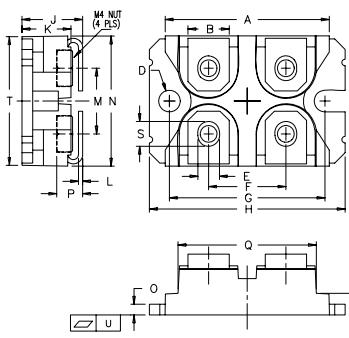
Symbol **Test Conditions****Characteristic Values**(T_J = 25°C, unless otherwise specified)

Min. Typ. Max.

g_{fs}	V _{DS} = 20 V; I _D = 24 A, pulse test	35	53	S
C_{iss} C_{oss} C_{rss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz	8860	pF	
		850	pF	
		60	pF	
t_{d(on)} t_r t_{d(off)} t_f	V _{GS} = 10 V, V _{DS} = 24 A R _G = 2 Ω (External)	30	ns	
		25	ns	
		85	ns	
		22	ns	
Q_{g(on)} Q_{gs} Q_{gd}	V _{GS} = 10 V, V _{DS} = 0.5 V _{DSS} , I _D = 24 A	150	nC	
		50	nC	
		50	nC	
R_{thJC}			0.2	°C/W
R_{thCS}	SOT-227B	0.05		°C/W

Source-Drain Diode**Characteristic Values**(T_J = 25°C, unless otherwise specified)

Symbol	Test Conditions	Min.	Typ.	Max.
I_s	V _{GS} = 0 V		48	A
I_{SM}	Repetitive		110	A
V_{SD}	I _F = I _S , V _{GS} = 0 V, Pulse test, t ≤ 300 μs, duty cycle d ≤ 2 %		1.5	V
t_{rr} Q_{RM} I_{RM}	I _F = 25A, -di/dt = 100 A/μs V _R = 100V		200	ns
			0.8	μC
			6.0	A

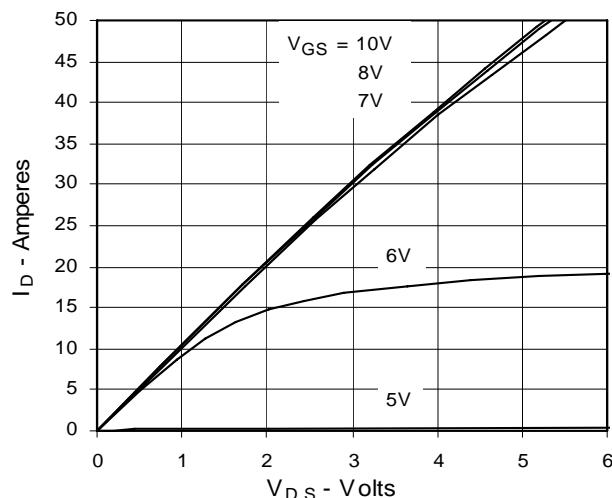
SOT-227B (IXFN) Outline

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.240	1.255	31.50	31.88
B	.307	.323	7.80	8.20
C	.161	.169	4.09	4.29
D	.161	.169	4.09	4.29
E	.161	.169	4.09	4.29
F	.587	.595	14.91	15.11
G	1.186	1.193	30.12	30.30
H	1.496	1.505	38.00	38.23
J	.460	.481	11.68	12.22
K	.351	.378	8.92	9.60
L	.030	.033	0.76	0.84
M	.496	.506	12.60	12.85
N	.990	1.001	25.15	25.42
O	.078	.084	1.98	2.13
P	.195	.235	4.95	5.97
Q	1.045	1.059	26.54	26.90
R	.155	.174	3.94	4.42
S	.186	.191	4.72	4.85
T	.968	.987	24.59	25.07
U	-.002	.004	-0.05	0.1

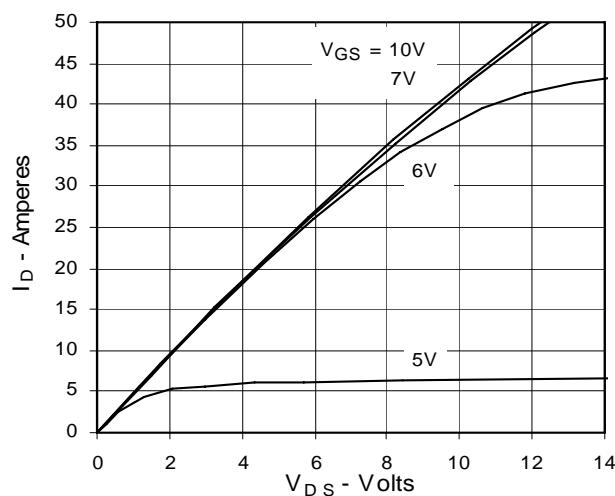
IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 one or more of the following U.S. patents: 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2

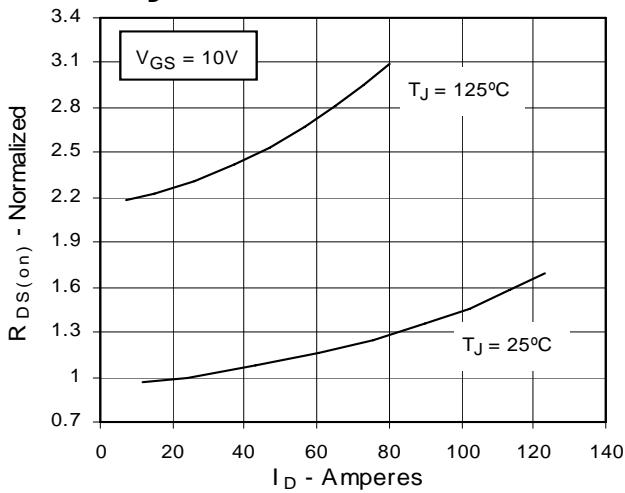
**Fig. 1. Output Characteristics
@ 25°C**



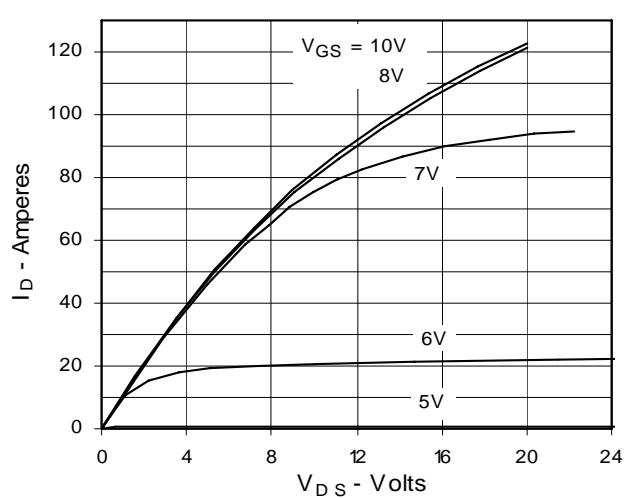
**Fig. 3. Output Characteristics
@ 125°C**



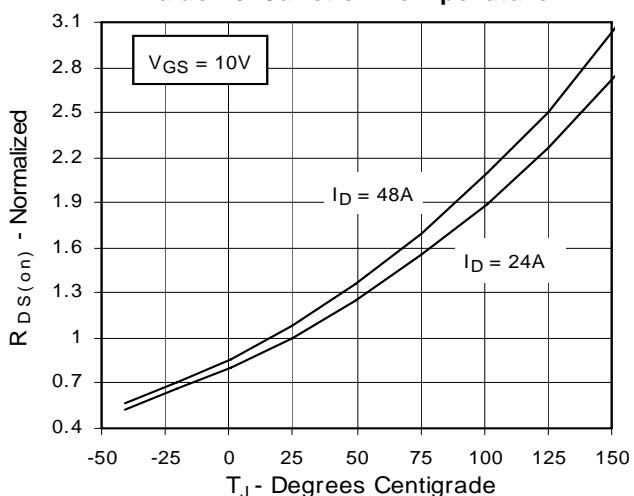
**Fig. 5. $R_{DS(on)}$ Normalized to
 $I_D = 24A$ Value vs. Drain Current**



**Fig. 2. Extended Output Characteristics
@ 25°C**



**Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 24A$
Value vs. Junction Temperature**



**Fig. 6. Drain Current vs. Case
Temperature**

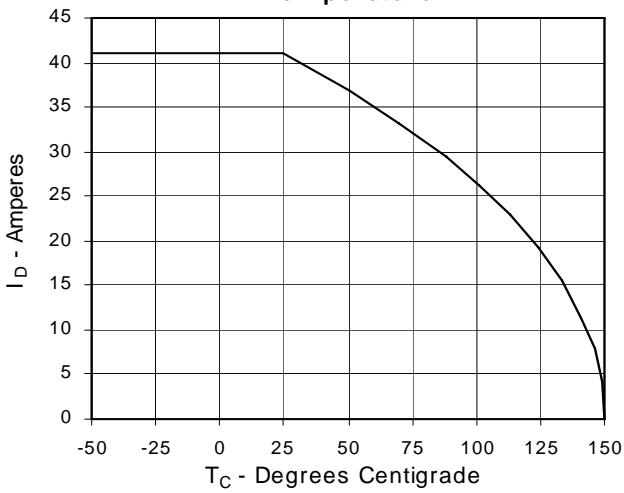
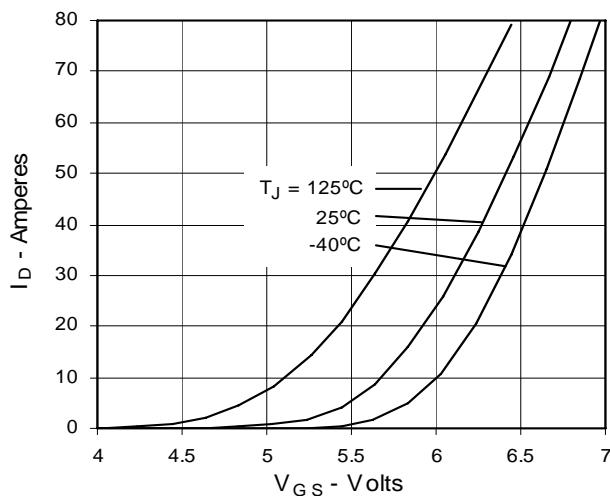
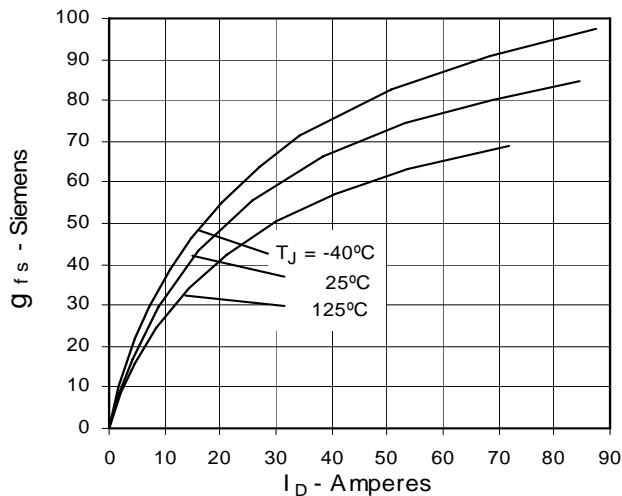
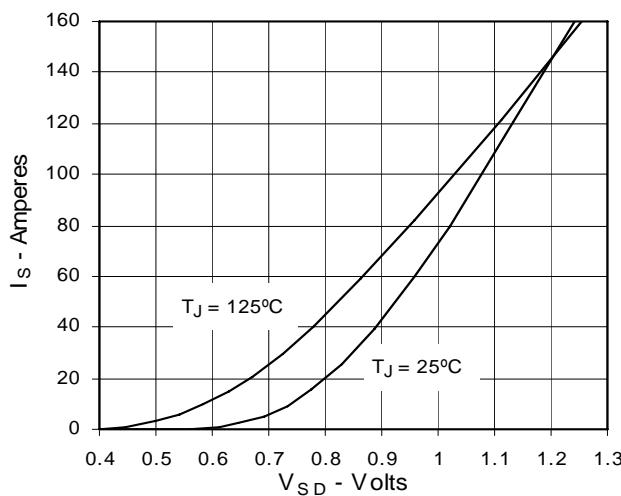
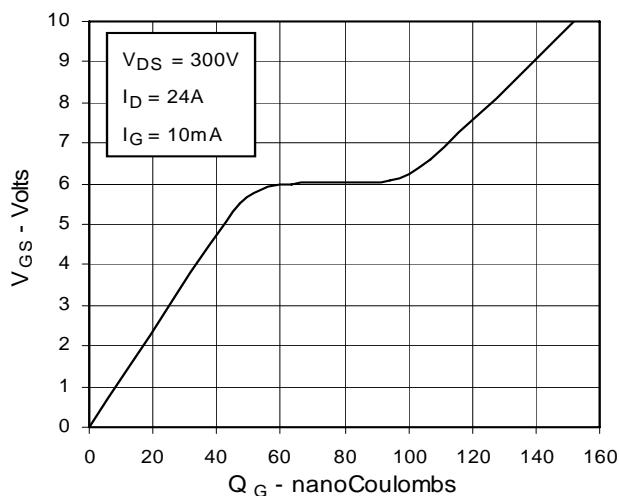
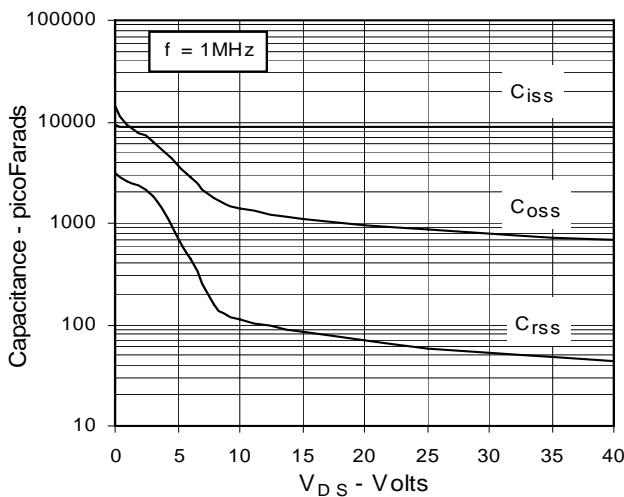


Fig. 7. Input Admittance**Fig. 8. Transconductance****Fig. 9. Source Current vs. Source-To-Drain Voltage****Fig. 10. Gate Charge****Fig. 11. Capacitance****Fig. 13. Maximum Transient Thermal Resistance**